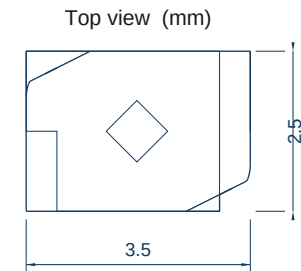
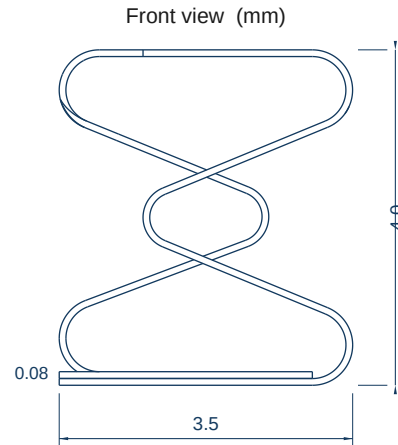
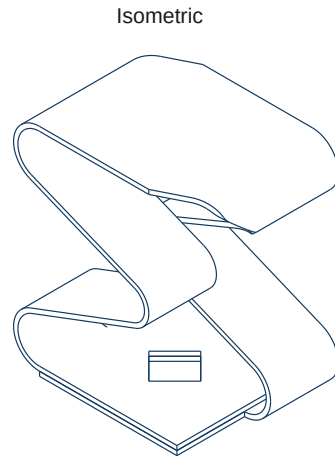




Type 8-04 B804-25035040

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL	VALUE
Thickness	0.080 mm (measured)
Width	2.5 mm +/- 0.2
Length	3.5 mm +/- 0.2
Height	4.0 mm +/- 0.2
Form	Z-form: 2 plates joined by crossing spring arms
End curls	R0.440 CL (R0.400 inner / R0.480 outer) x4
Centre bends	R0.340 CL (R0.300 inner / R0.380 outer) x2
Plate corners	R1.00 rounded, 2 opposite corners
Base hole	diamond 0.96 across corners (0.679 side) at 1.73 / 1.25 from the corner
Developed blank	15.96 x 2.5 mm
Material / plating	BeCu, Gold-plated (G)
Volume / mass	3.129 mm ³ 26.1 mg (BeCu)
File format	STEP AP214

PRODUCT DATA	VALUE
Mfr P/N	B804-25035040G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 3.5x2.5x4.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-8-04.html